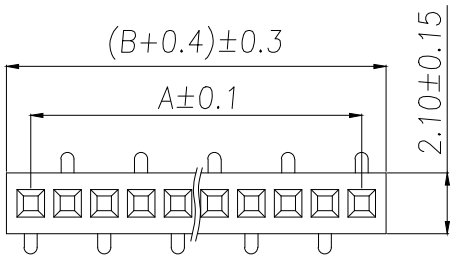
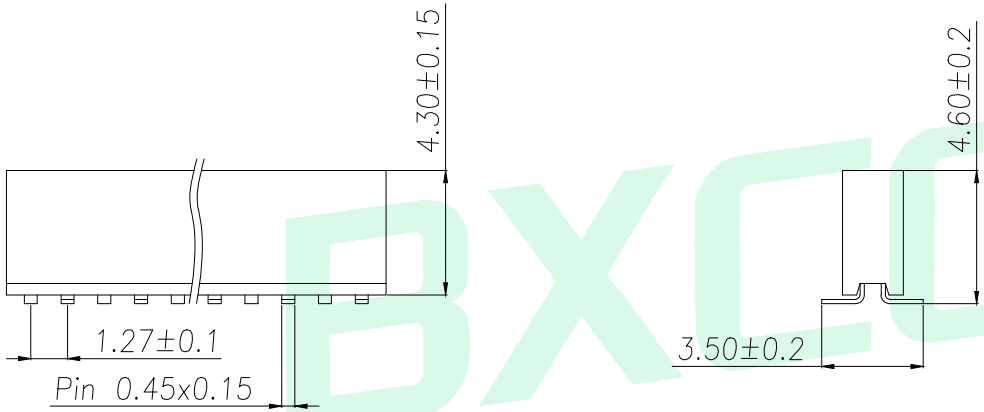
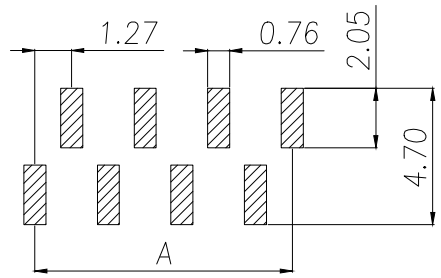
REV.	DESCRIPTION	ECN NO.	NAME	DATE



SPECIFICATIONS
Current Rating: 1.0 Amps
Withstanding Voltage:AC 500V
Insulation Resistance:1000MΩ Min
Contact Resistance:20mΩ Max
Operation Temperature:−40°to+105°
Insrlator Material:Polyester(UL94V−0)
Contact Material:Phosphor bronze
Standard:PA6T
Contact Plating:Gold Flash
Max.Processing Temp:240°C for30−60seconds
(260°C for5seconds)



P/N	PIN	DIM.A	DIM.B
AM−PM1.27−V14−1*1P	1	0.00	1.27
AM−PM1.27−V14−1*2P	2	1.27	2.54
AM−PM1.27−V14−1*3P	3	2.54	3.81
AM−PM1.27−V14−1*4P	4	3.81	5.08
AM−PM1.27−V14−1*5P	5	5.08	6.35
AM−PM1.27−V14−1*6P	6	6.35	7.62
AM−PM1.27−V14−1*7P	7	7.62	8.89
AM−PM1.27−V14−1*8P	8	8.89	10.16
AM−PM1.27−V14−1*9P	9	10.16	11.43
.....	.....	.....	.....
AM−PM1.27−V14−1*50P	50	(PIN−1)x1.27	(PIN)x1.27



RECOMMEND P.C.B LAYOUT
PCB TOLERANCE:±0.05 (TOP VIEW)

GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD		BXCONN®
DIM. TOL. x. ±0.30 x.x ±0.20 x.xx ±0.10 GENERAL ANGLE: x.° ±5° x.x° ±1° x.xx° ±0.5°	TITLE: 1.27FH H4.3 1xNPin SMT W2.1 U型 PC3.5 PB4.6 6T(左前右后)		
	DWG. NO.: AM−PM1.27−V14−1*NP	CHECKED: MAX	
	PART NO.: AM−PM1.27−V14−1*NP	DRAWN: ELLA	
	UNIT: mm / SCALE: none / SHEET: 1of 1 / DWG. SIZE: A4 / LAYER: bxconn	APPROVED: WILL	